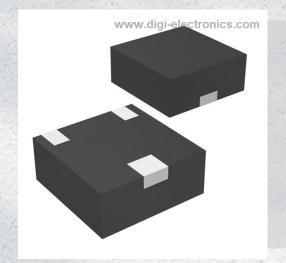


DMP21D0UFD-7 Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number DMP21D0UFD-7-DG

Manufacturer Diodes Incorporated

Manufacturer Product Number DMP21D0UFD-7

Description MOSFET P-CH 20V 820MA 3DFN

Detailed Description P-Channel 20 V 820mA (Ta) 490mW (Ta) Surface Mo

unt X1-DFN1212-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
DMP21D0UFD-7	Diodes Incorporated
Series:	Product Status:
	Active
FET Type:	Technology:
P-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
20 V	820mA (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
1.5V, 4.5V	495mOhm @ 800mA, 4.5V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
1.2V @ 250µA	3 nC @ 4.5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±8V	80 pF @ 10 V
FET Feature:	Power Dissipation (Max):
	490mW (Ta)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
X1-DFN1212-3	3-UDFN
Base Product Number:	
DMP21	

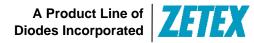
Environmental & Export classification

8541.21.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	







DMP21D0UFD

20V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)} Max	I _D max T _A = 25°C (Notes 4)
-20V	495mΩ @ V _{GS} = -4.5V	-1.14A
	730mΩ @ V _{GS} = -2.5V	-0.94A
	960mΩ @ V _{GS} = -1.8V	-0.85A
	1300mΩ @ $V_{GS} = -1.5V$	-0.75A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

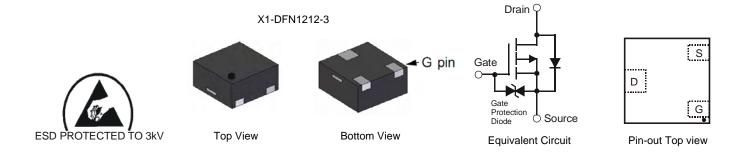
Portable electronics

Features and Benefits

- Low Gate Threshold Voltage
- · Fast Switching Speed
- ESD Protected Gate 3KV
- Totally Lead-Free & Fully RoHS compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: X1-DFN1212-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.005 grams (approximate)



Ordering Information (Note 3)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMP21D0UFD-7	K21	7	8	3000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



K21 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Kev

Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Υ		Z		Α	Е	3	С		D		Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D





Maximum Ratings @TA = 25°C unless otherwise specified

Ch	aracterist	ic	Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±8	V
	0	T _A = 25°C (Note 4)		-1.14	
Continuous Drain Current	Steady State	$T_A = 85^{\circ}C \text{ (Note 4)}$	I_{D}	-0.83	A
	State	T _A = 25°C (Note 5)		-0.82	
Pulsed Drain Current (Note 6)			I _{DM}	-4.0	A

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Dawar Dissination	(Note 4)		930	mW
Power Dissipation	(Note 5)	P _D	490	mW
Thermal Desistance Junction to Ambient	(Note 4)	0	135	°C/W
Thermal Resistance, Junction to Ambient	(Note 5)	R _{0JA}	256	°C/W
Operating and Storage Temperature Range	T_{J}, T_{STG}	-55 to +150	°C	

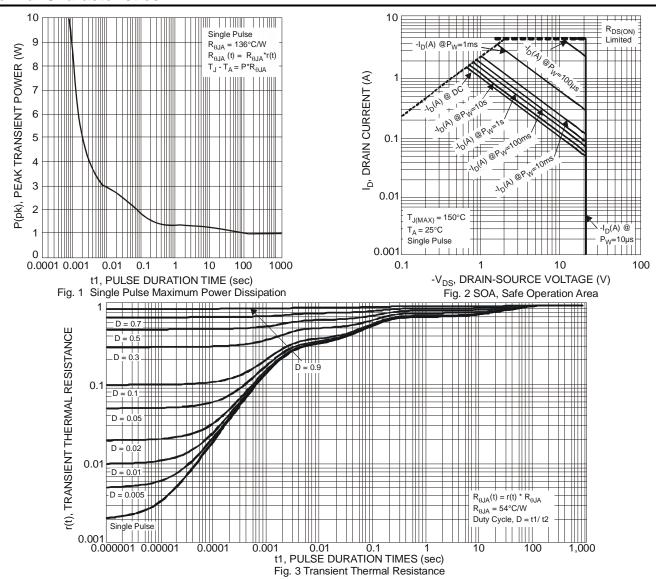
Notes:

- 5. Same as note 4, except the device is mounted on minimum recommended pad layout.
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

^{4.} For a device surface mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.



Thermal Characteristics





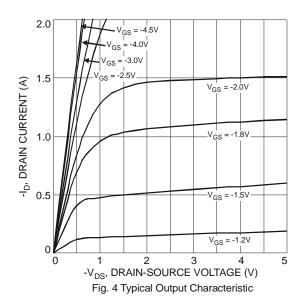
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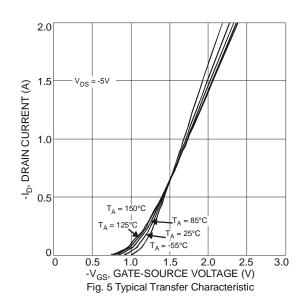
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)		1		ı		T	
Drain-Source Breakdown Voltage	BV _{DSS}	-20	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	-1	μΑ	$V_{DS} = -20V$, $V_{GS} = 0V$	
Gate-Source Leakage	Igss	-	•	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(th)}$	-0.45	-0.7	-1.2	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
				495		$V_{GS} = -4.5V, I_D = -800mA$	
Chatia Brain Causas On Basistanas				730	0	$V_{GS} = -2.5V, I_D = -700mA$	
Static Drain-Source On-Resistance	R _{DS} (ON)	-	-	960	mΩ	$V_{GS} = -1.8V, I_D = -100mA$	
				1300		$V_{GS} = -1.5V, I_D = -100mA$	
Forward Transfer Admittance	Y _{fs}	50	-	-	mS	$V_{DS} = -3V, I_{D} = -300 \text{mA}$	
Diode Forward Voltage	V _{SD}	-	-	-1.2	V	$V_{GS} = 0V, I_{S} = -300mA$	
DYNAMIC CHARACTERISTICS				•			
Input Capacitance	C _{iss}	-	76.5	-	pF	.,,	
Output Capacitance	Coss	-	13.7	-	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	10.7	-	pF		
Gate Resistance	Rg	-	195	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (Note 8)	Qg	-	1.5	-	nC	$V_{GS} = -8V, V_{DS} = -15V, I_{D} = -1A$	
Total Gate Charge (Note 8)	Qg	-	1.0	-	nC	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
Gate-Source Charge	Q _{gs}	-	0.2	-	nC	$V_{GS} = -4.5V, V_{DS} = -15V,$	
Gate-Drain Charge	Q _{qd}	-	0.3	-	nC	I _D = -1A	
Turn-On Delay Time	t _{D(on)}	-	7.1	-	ns		
Turn-On Rise Time	t _r	-	8.0	-	ns	V _{DS} = -10V, -I _D = 1A	
Turn-Off Delay Time	t _{D(off)}	-	31.7	-	ns	$V_{GS} = -4.5V, R_G = 6\Omega$	
Turn-Off Fall Time	t _f	-	18.5	-	ns	7	

Notes:

- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guarantee by design.



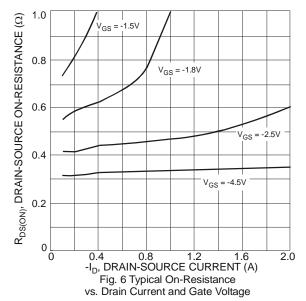


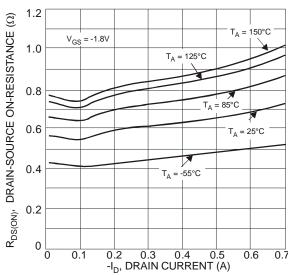


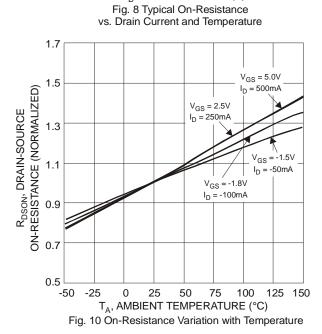
A Product Line of Diodes Incorporated

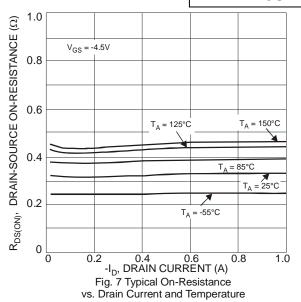


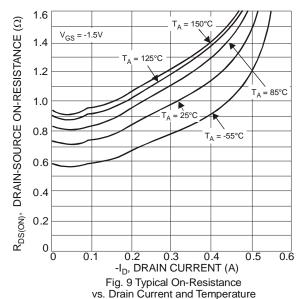
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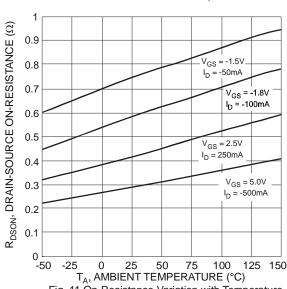
















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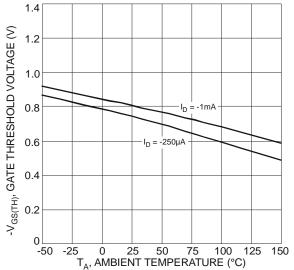


Fig. 12 Gate Threshold Variation vs. Ambient Temperature

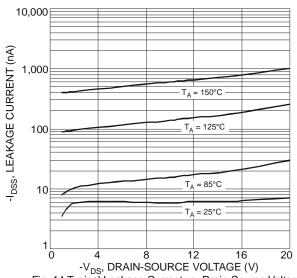
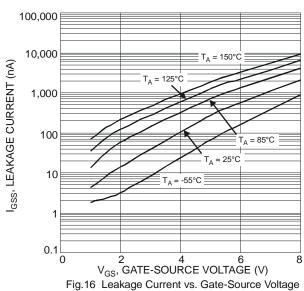
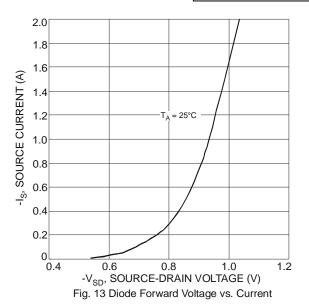
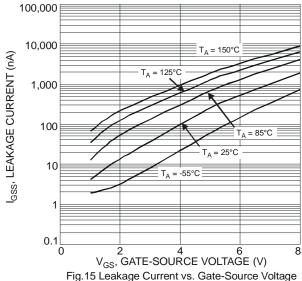
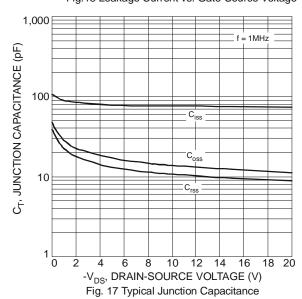


Fig. 14 Typical Leakage Current vs. Drain-Source Voltage

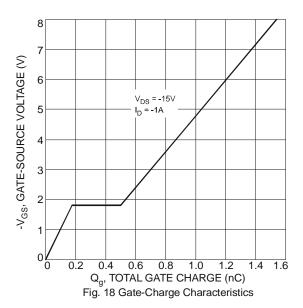




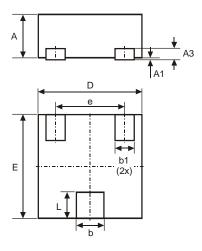






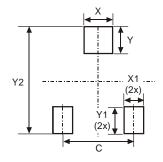


Package Outline Dimensions



Х	X1-DFN1212-3							
Dim	Min	Max	Тур					
Α	0.47	0.53	0.50					
A1	0	0.05	0.02					
А3	•	•	0.13					
b	0.27	0.37	0.32					
b1	0.17	0.27	0.22					
D	1.15	1.25	1.20					
Е	1.15	1.25	1.20					
е	-	-	0.80					
L	0.25	0.35	0.30					
All Di	All Dimensions in mm							

Suggested Pad Layout



Dimensions	Value (in mm)
С	0.80
Х	0.42
X1	0.32
Y	0.50
Y1	0.50
Y2	1.50





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